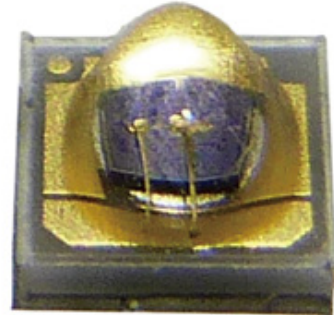


NMOP-10132

SURFACE MOUNT LED TAPE AND REEL

Features:

1. Top view LED.
2. Small package with high efficiency
3. Soldering methods: IR reflows soldering.
4. RoHS compliant
5. Pb Free



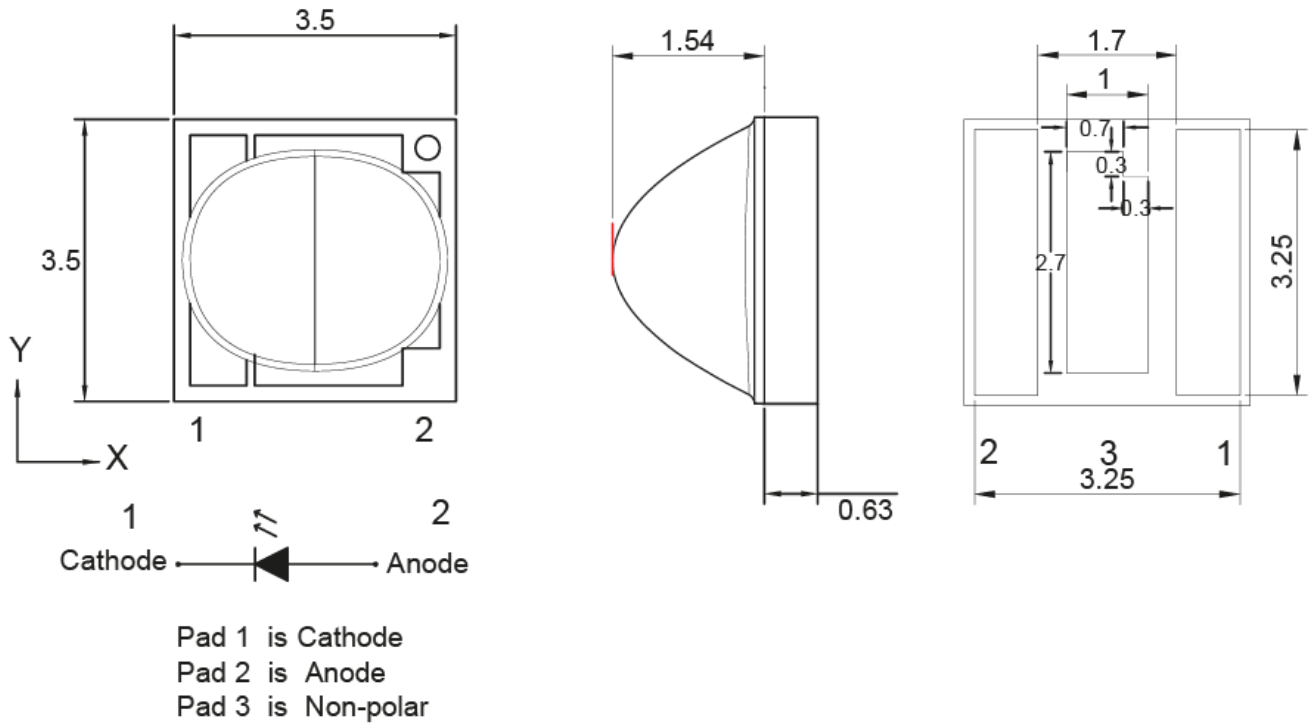
Applications:

1. CCD Camera.
2. infrared applied system

Device Selection Guide

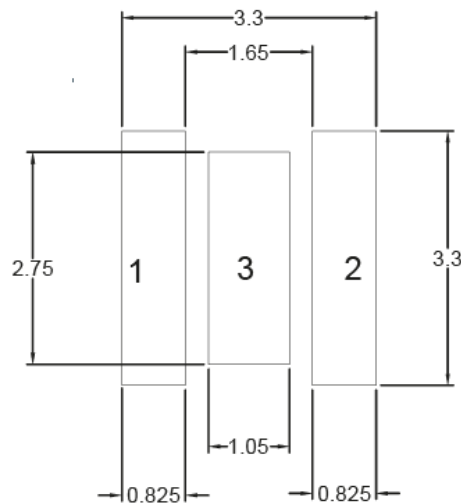
Part No	Material	Color	
		Emitted	Lens
NMOP-10132	AlGaInP	Infrared	Water Clear

Package Dimensions



Note : 1. All dimension are in millimeter tolerance is ± 0.1 mm unless otherwise noted.
 2. Specifications are subject to change without notice.

Recommended Soldering Pad Dimensions



Note : The tolerances unless mentioned is ± 0.1 mm, Unit=mm.

Absolute Maximum Ratings at Ta=25° C

Parameter	Symbol	Ratings	UNIT
Power Consumption	P_{tot}	2.6	W
DC Forward Current	I_F	1000	mA
Reverse Current (VR=5V)	I_r	10	μ A
Peak pulse current Duty 1/10@10KHz	I_{FP}	2000	mA
ESD Sensitivity	HMB 100pf/1.5K Ω	2000	V
	MM 200pf/0 Ω	150	V
LED junction Temperature	T_j	145	$^{\circ}$ C
Thermal resistance	Rth j-s	8	$^{\circ}$ C/W
Operating Temperature	Topr	-40 ~ +125	$^{\circ}$ C
Storage Temperature	Tstg	-40 ~ +125	$^{\circ}$ C
Soldering Temperature	T_p	260	$^{\circ}$ C

Typical Electrical & Optical Characteristics (Ta=25° C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Radiant Intensity	I _e	210	270	---	mW/sr	IF=1A
Radiant Flux	Φ _e	---	950	---	mW	IF=1A
Peak Emission Wavelength	λ _P	---	730	---	nm	IF=1A
Spectral Line Half Width	Δλ	---	40	---	nm	IF=1A
Forward Voltage	V _F	1.7	---	2.6	V	IF=1A
Viewing Angle	2θ 1/2	(X)150 (Y) 100			deg	IF=1A

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.
 2.The radiant intensity data did not including ±15% testing tolerance.

Radiant Intensity Classification

BIN CODE	I _e (mW/sr) at 1A	
	Min.	Max.
E2	210	250
E3	250	300
E4	300	360
E5	360	430

Forward Voltage Classification

BIN CODE	V _f (V) at 1A	
	Min.	Max.
1	1.7	2
2	2	2.3
3	2.3	2.6

Typical Electro-Optical Characteristics Curve

Fig.1 Relative Intensity VS. Forward Current

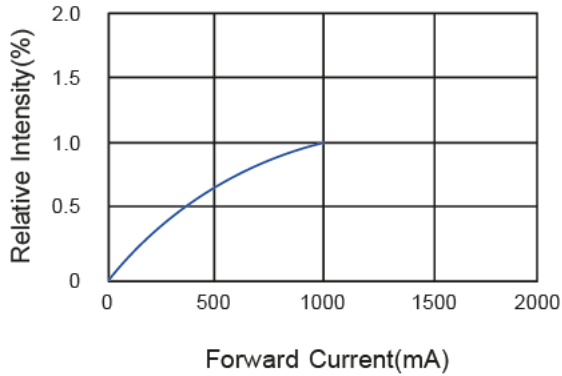


Fig.2 Forward Current VS. Ambient Temperature

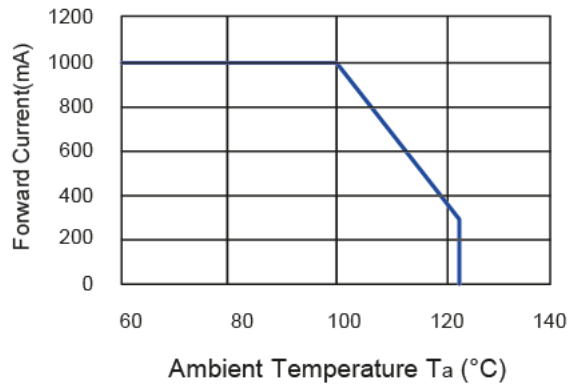


Fig.3 Relative Radiant Power VS. Wavelength

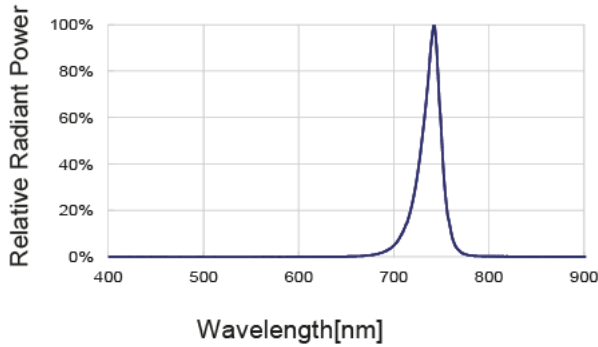


Fig.4 Forward Voltage VS. Forward Current

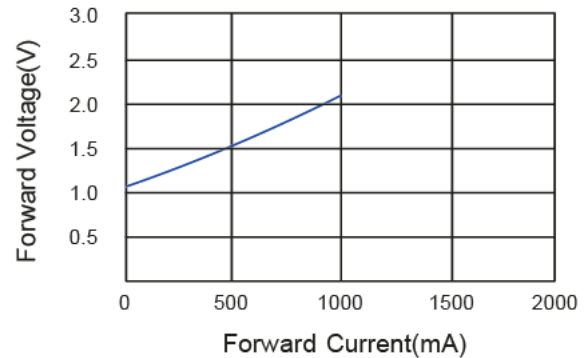
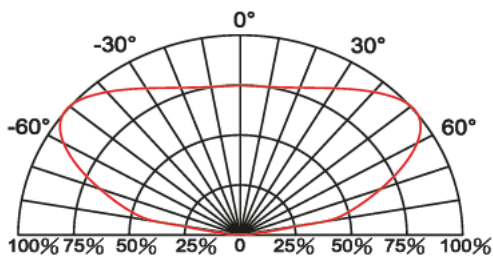
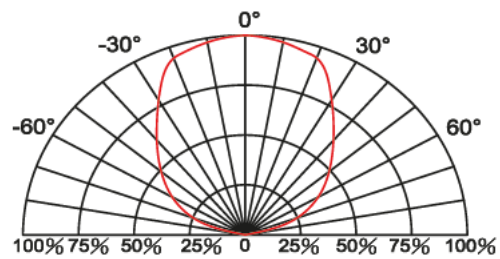


Fig.5 Directive Radiation

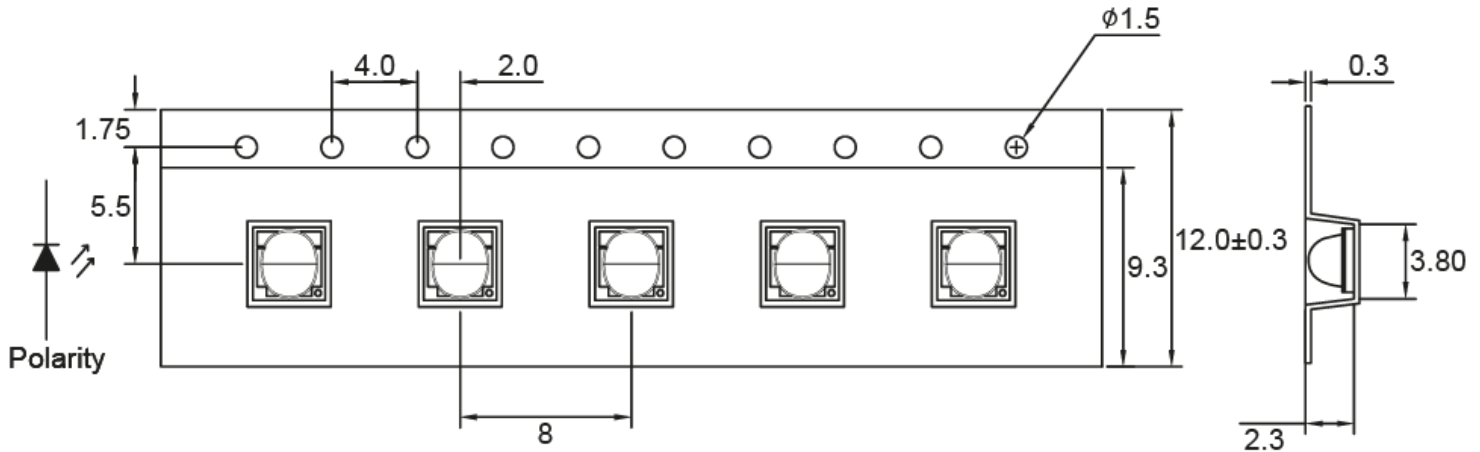


X-X



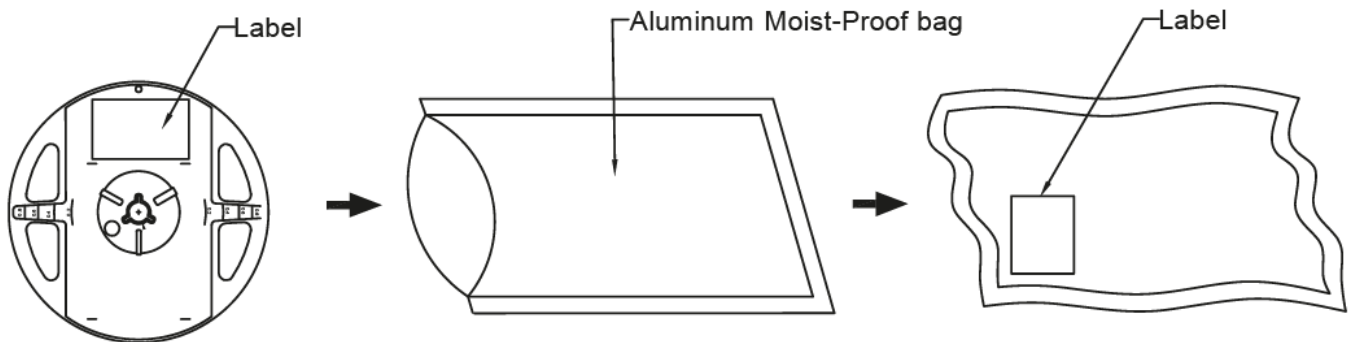
Y-Y

Carrier Type Dimensions



Note : The tolerances unless mentioned is ±0.1mm, Angle ± 0.5. Unit=mm.

Packing Specifications



Part No.	Description	Quantity/Reel
NMOP-10132	12.0mm tape, 7" reel	500 PCS

NMOP-10132

Label Explanation



N Neumüller
Elektronik GmbH
www.neumueller.com

Typ / Part No. _____

Date Code / Rank _____

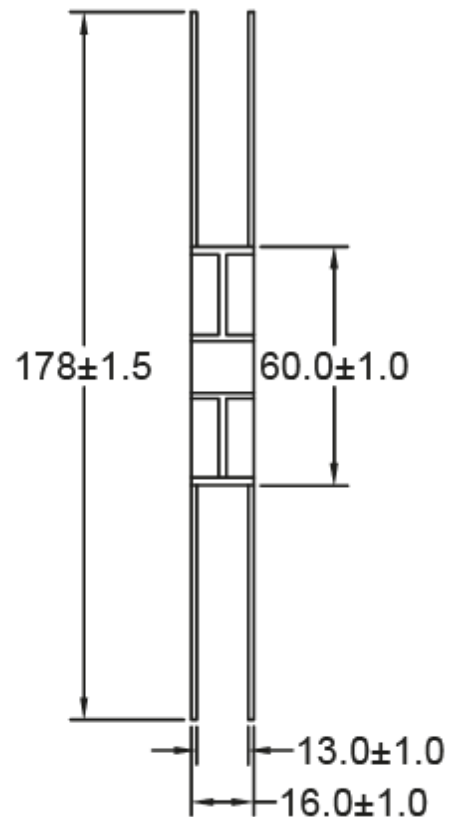
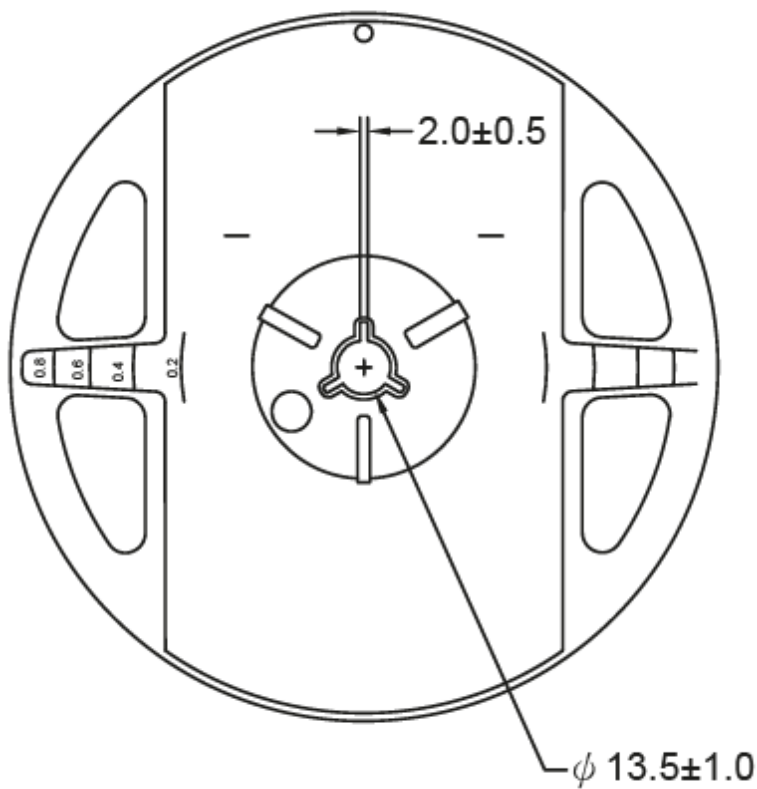
Menge / Quantity _____

Kunde / Customer _____

BIN : Luminous Intensity

VF : Forward Voltage

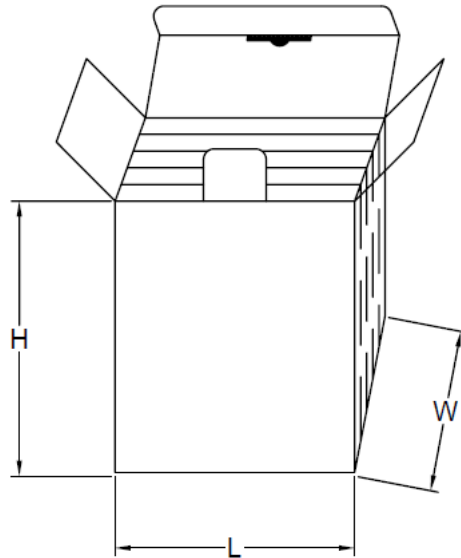
Reel Dimensions



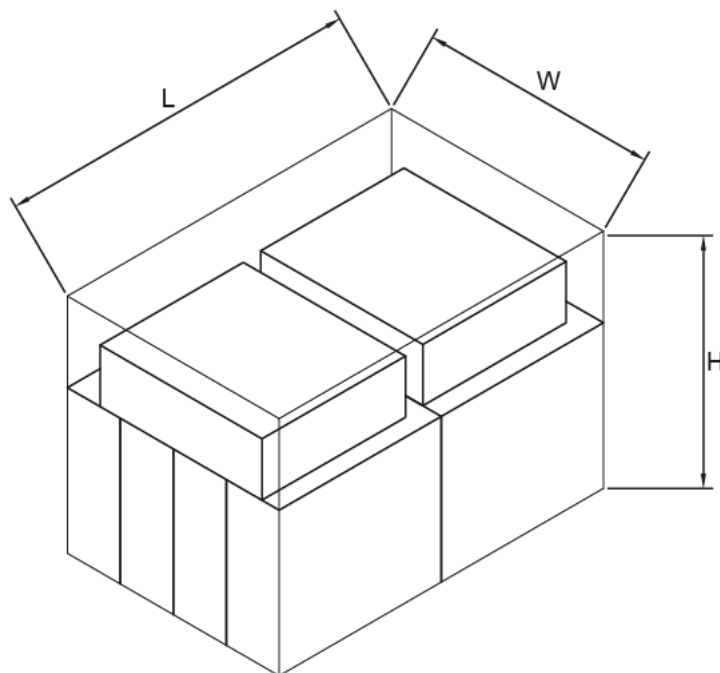
NMOP-10132

Box Explanation

1. 4 BAG / INNER BOX
2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm

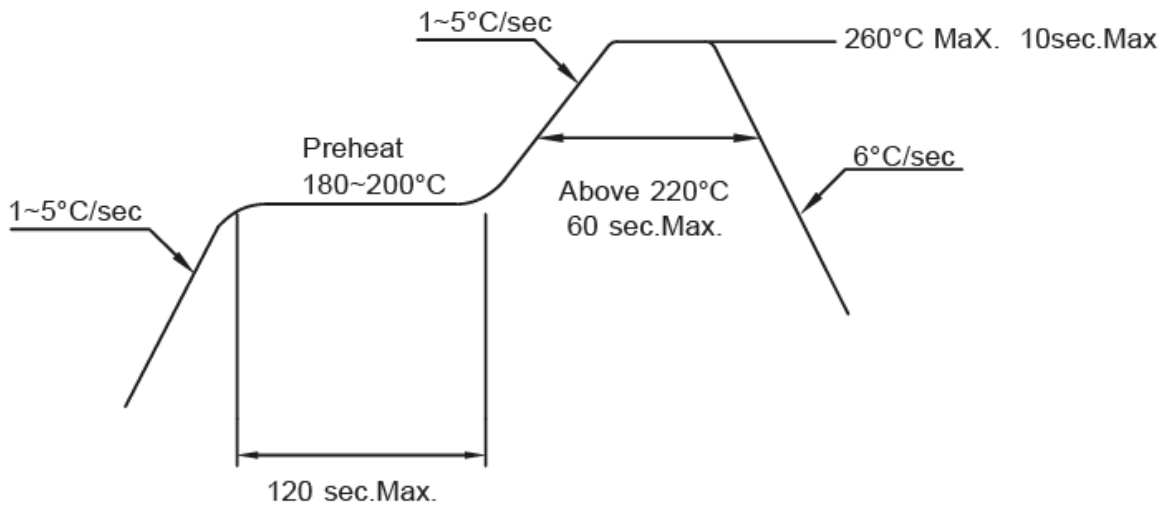


3. 10 INNER BOXES / CARTON
4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm



Recommended Soldering Conditions

PB-Free Reflow Solder



- Note:
- 1.Reflow soldering should not be done more than two times.
 - 2.When soldering,do not put stress on the LEDs during heating.
 - 3.After soldering,do not warp the circuit board.

Precautions For Use:

Storage time:

1. Calculated shelf life before opening is 12 months at $< 30^{\circ}\text{C}$ and $< 90\%$ relative humidity (RH)
2. After bag is opened, devices which will be subjected to reflow soldering or other high temperature processes must be
 - a) Assembled within 168 hours in an environment of $\leq 30^{\circ}\text{C}$ / 60% RH, or
 - b) Stored at ambient of 10% RH or less
3. Devices are required baking before assembly if:
 - a) Humidity Indicator Card reads $>10\%$ (for level 2a -5a) or $>60\%$ (for level 2) at ambient temperature $23\pm 5^{\circ}\text{C}$
 - b) 2.a) or 2.b) doesn't meet
4. If baking is required, devices should be baked for >24 hours at $60\pm 5^{\circ}\text{C}$ / 5% RH. Performing baking only once, and using the baked devices within 8 hours.

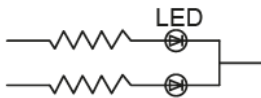
MSL LEVEL 3

Drive Method:

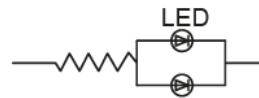
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

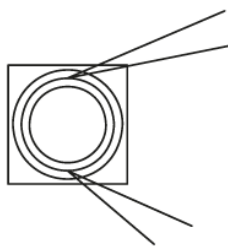
Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

Reliability Test:

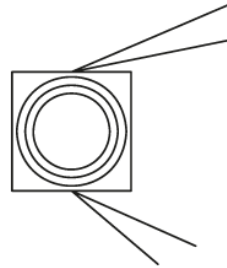
Classification	Test Item	Test Condition	Sample Size
Endurance Test	Operating Life Test	1. Ta=25°C 2. If=1A 3. t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature Storage Test	1. Ta=100°C±5°C 2. t=1000 hrs (-24hrs,+72hrs)	22
	Low Temperature Storage Test	1. Ta=-40°C±5°C 2. t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature High Humidity Storage Test	1. Ta=85°C 2. RH=85% 3. t=1000hrs(-24hrs,+72hrs)	22
Environmental Test	Thermal Shock Test	1. Ta=100°C±5°C ~ -40°C±5°C 20min/ 10sec / 20min 2. total 100 cycles	22
	Temperature Cycling	1. 100°C±5°C ~ -40°C±5°C 30mins / 5mins / 30mins 2. 100 Cycles	22
	IR Reflow	1. T=260°C Max. 10sec.Max. 2. 6 Min	22

Please follow the guideline to grab LEDs

- don't touch lens with the fingers
- use tweezers to grab LED
- don't apply more than 4N of lens(400G) directly onto the lens
- don't touch lens with the tweezers



Wrong(x)



Correct(o)

Lens cleaning

in the case where a minimal level of dirt and dust particles can not be guaranteed, a suitable cleaning solution can be applied to the lens surface

- try a gentle swabbing using a lint-free swab
- if needed, the use of lint-free swab and isopropyl alcohol used gently removes dirt from the lens
- don't use other solvents as they may directly react with the led assembly.
- don't use ultrasonic cleaning that the led will be damaged

Disclaimer

The information in this data sheet subject to change without notice.
Always make sure to use the most recent release, or consult with us before your final selection.